

CMOS Digital Integrated Circuits Silicon Monolithic

## TC7SPN334L6X

#### 1. Functional Description

· Low-Voltage, Low-Power 1-Bit Dual-Supply Bus Buffer

#### 2. General

The TC7SPN334L6X is a CMOS high-speed single-bit bus buffer designed to interface between two subsystems operating at different voltage levels between 1.1 V and 3.6 V.

Its input and output provide overvoltage tolerance and accept up to 3.6 V in power-down mode (power-down protection).

The TC7SPN334L6X dual-supply bus buffer operates with a  $V_{CCA}$  of 1.2 V, 1.5 V, 1.8 V, or 2.5 V bus and a  $V_{CCB}$  of 1.8 V, 2.5 V or 3.3 V. It is suitable for single-bit interfacing.

The A input interfaces with the 1.2 V, 1.5 V, 1.8 V or 2.5 V bus, and the B output interfaces with the 1.8 V, 2.5 V, 3.3 V bus.

All inputs are equipped with protection circuits against static discharge or transient excess voltage.

#### 3. Features

- (1) Level converter for interfacing 1.2 V to 1.8 V, 1.2 V to 2.5 V, 1.2 V to 3.3 V, 1.5 V to 2.5 V, 1.5 V to 3.3 V, 1.8 V to 2.5 V, 1.8 V to 3.3 V or 2.5 V to 3.3 V system.
- (2) High-speed operation:  $t_{pd} = 3.2 \text{ ns}$  (max)  $(V_{CCA} = 2.5 \pm 0.2 \text{ V}, V_{CCB} = 3.3 \pm 0.3 \text{ V})$

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t_{pd} = 3.8 ns (max) (V_{CCA} = 1.8 ± 0.15 V, V_{CCB} = 3.3 ± 0.3 V)
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$$t_{pd}$$
 = 4.5 ns (max) ( $V_{CCA}$  = 1.5 ± 0.1 V,  $V_{CCB}$  = 3.3 ± 0.3 V)

$$t_{pd}$$
 = 6.2 ns (max) (V\_{CCA} = 1.2  $\pm$  0.1 V, V\_{CCB} = 3.3  $\pm$  0.3 V)

$$t_{pd}$$
 = 4.9 ns (max) ( $V_{CCA}$  = 1.8  $\pm$  0.15 V,  $V_{CCB}$  = 2.5  $\pm$  0.2 V)

$$t_{pd} = 5.5 \text{ ns (max)} (V_{CCA} = 1.5 \pm 0.1 \text{ V}, V_{CCB} = 2.5 \pm 0.2 \text{ V})$$

$$t_{pd} = 6.9 \text{ ns (max)} \text{ ($V_{CCA} = 1.2 \pm 0.1$ V, $V_{CCB} = 2.5 \pm 0.2$ V)}$$
 
$$t_{pd} = 9.7 \text{ ns (max)} \text{ ($V_{CCA} = 1.2 \pm 0.1$ V, $V_{CCB} = 1.8 \pm 0.15$ V)}$$

(3) Output current:  $I_{OHB}/I_{OLB} = \pm 3 \text{ mA (min)} (V_{CCB} = 3.0 \text{ V})$ 

$$I_{OHB}/I_{OLB} = \pm 2 \text{ mA (min)} (V_{CCB} = 2.3 \text{ V})$$

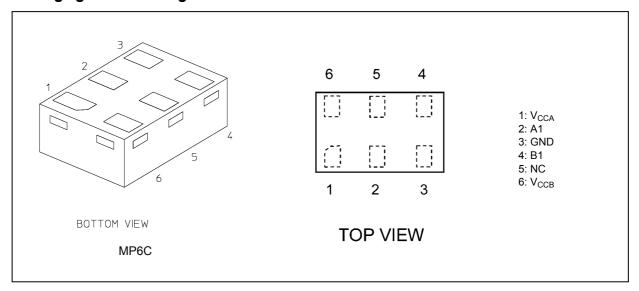
$$I_{OHB}/I_{OLB} = \pm 0.5 \text{ mA (min) (V}_{CCB} = 1.65 \text{ V)}$$

- (4) Latch-up resistance: -300 mA
- (5) ESD resistance: Machine model  $\geq \pm 200$  V, Human body model  $\geq \pm 2000$  V
- (6) Ultra-small package: MP6C
- (7) 3.6 V tolerant function and power-down protection provided on all inputs and output.

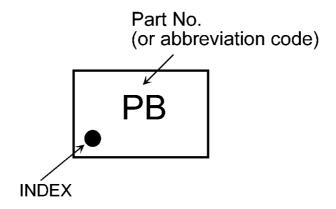
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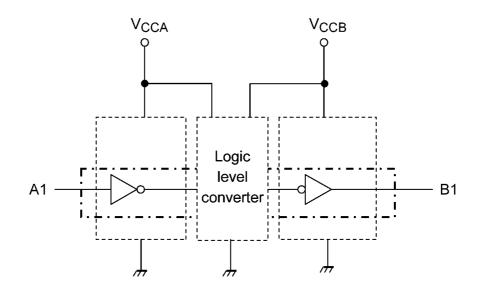
## 4. Packaging and Pin Assignment



## 5. Marking



### 6. Block Diagram



Rev.2.0



#### 7. Principle of Operation

#### 7.1. Truth Table

Input A1	Output B1
L	L
Н	Н

#### 8. Absolute Maximum Ratings (Note)

Characteristics	Symbol	Note	Test Condition	Rating	Unit
Supply voltage	V <sub>CCA</sub>	(Note 1)	_	-0.5 to 4.6	V
	V <sub>CCB</sub>			-0.5 to 4.6	
Input voltage (A1)	V <sub>IN</sub>		_	-0.5 to 4.6	٧
Output voltage (B1)	V <sub>OUT</sub>		V <sub>CCB</sub> = 0 V	-0.5 to 4.6	V
		(Note 2)	_	-0.5 to V <sub>CCB</sub> + 0.5	
Input diode current	I <sub>IK</sub>		_	-25	mA
Output diode current	I <sub>OK</sub>	(Note 3)	_	±50	
Output current	I <sub>OUT</sub>		_	±6	mA
V <sub>CC</sub> /ground current per supply pin	I <sub>CCA</sub>		_	±25	mA
	I <sub>CCB</sub>			±50	
Power dissipation	P <sub>D</sub>	(Note 4)	_	250	mW
Storage temperature	T <sub>stg</sub>		_	-65 to 150	°C

Note: Exceeding any of the absolute maximum ratings, even briefly, lead to deterioration in IC performance or even destruction.

Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 1: Don't supply a voltage to  $V_{CCB}$  pin when  $V_{CCA}$  is in the OFF state.

Note 2: High (H) or Low (L) state. I<sub>OUT</sub> absolute maximum rating must be observed.

Note 3:  $V_{OUT} < GND$ ,  $V_{OUT} > V_{CC}$ 

Note 4: Mounted on an FR4 board



## 9. Operating Ranges (Note)

Characteristics	Symbol	Note	Test Condition	Rating	Unit
Supply voltage	V <sub>CCA</sub>		_	1.1 to 2.7	V
	V <sub>CCB</sub>			V <sub>CCA</sub> to 3.6	
Input voltage (A1)	V <sub>IN</sub>			0 to 3.6	V
Output voltage (B1)	V <sub>OUT</sub>	(Note 1)	_	0 to 3.6	V
		(Note 2)		0 to V <sub>CCB</sub>	
Output current (B1)	I <sub>OUT</sub>		V <sub>CCB</sub> = 3.0 to 3.6 V	±3	mA
			V <sub>CCB</sub> = 2.3 to 2.7 V	±2	
			V <sub>CCB</sub> = 1.65 to 1.95 V	±0.5	
Input rise time	dt/dv		$V_{IN}$ = 0.8 to 2.0 V, $V_{CCA}$ = 2.5 V,	0 to 10	ns/V
Input fall time			V <sub>CCB</sub> = 3.0 V	0 to 10	
Operating temperature	T <sub>opr</sub>		_	-40 to 85	°C

Note: The operating ranges must be maintained to ensure the normal operation of the device.

Unused inputs and bus inputs must be tied to either  $V_{CC}$  or GND. Please connect both bus inputs and the bus outputs with  $V_{CC}$  or GND when the I/O of the bus terminal changes by the function. In this case, please note that the output is not short-circuited.

Note 1: Output in OFF state.

Note 2: High (H) or Low (L) state.

Rev.2.0



#### 10. Electrical Characteristics

## 10.1. DC Characteristics (Unless otherwise specified, $T_a$ = -40 to 85 °C, 1.1 V $\leq$ VCCA $\leq$ 2.7 V, 1.65 V $\leq$ VCCB $\leq$ 3.6 V )

Characteristics	Sym- bol	Test Condition		V <sub>CCA</sub> (V)	V <sub>CCB</sub> (V)	Min	Max	Unit
High-level input	V <sub>IHA</sub>	A1		1.1 ≤ V <sub>CCA</sub> < 1.4	1.65 to 3.6	0.65×V <sub>CCA</sub>	_	٧
voltage				1.4 ≤ V <sub>CCA</sub> < 1.65	1.65 to 3.6	0.65×V <sub>CCA</sub>	_	1
				1.65 ≤ V <sub>CCA</sub> < 2.3	2.3 to 3.6	0.65×V <sub>CCA</sub>	_	1
				$2.3 \leq V_{CCA} \leq 2.7$	2.7 to 3.6	1.6	_	1
Low-level input	V <sub>ILA</sub>	A1		1.1 ≤ V <sub>CCA</sub> < 1.4	1.65 to 3.6	_	0.30×V <sub>CCA</sub>	٧
voltage				1.4 ≤ V <sub>CCA</sub> < 1.65	1.65 to 3.6	_	0.30×V <sub>CCA</sub>	]
				1.65 ≤ V <sub>CCA</sub> < 2.3	2.3 to 3.6	_	0.35×V <sub>CCA</sub>	]
				$2.3 \leq V_{CCA} \leq 2.7$	2.7 to 3.6	_	0.7	]
High-level output	V <sub>OHB</sub>	A1 = V <sub>IH</sub>	I <sub>OHB</sub> = -100 μA	1.1 to 2.7	1.65 to 3.6	V <sub>CCB</sub> - 0.2	_	V
voltage	age		I <sub>OHB</sub> = -0.5 mA	1.1 to 1.65	1.65	1.25	_	]
			I <sub>OHB</sub> = -2 mA	1.1 to 2.3	2.3	1.7	_	
			I <sub>OHB</sub> = -3 mA	1.1 to 2.7	3.0	2.2	_	
Low-level output	V <sub>OLB</sub>	A1 = V <sub>IL</sub>	I <sub>OLB</sub> = 100 μA	1.1 to 2.7	1.65 to 3.6	_	0.2	٧
voltage			I <sub>OLB</sub> = 0.5 mA	1.1 to 1.65	1.65	_	0.3	
			I <sub>OLB</sub> = 2 mA	1.1 to 2.3	2.3	_	0.6	]
			I <sub>OLB</sub> = 3 mA	1.1 to 2.7	3.0	_	0.55	
Input leakage current	I <sub>IN</sub>	V <sub>IN</sub> = 0 to 3.6 V		1.1 to 2.7	1.65 to 3.6	_	±1.0	μА
Power-OFF leakage current	I <sub>OFF</sub>	V <sub>IN</sub> , B1 = 0 to 3.6 V		0	0	_	2.0	μА
Quiescent supply	I <sub>CCA</sub>	V <sub>IN</sub> = V <sub>CCA</sub> or GND		1.1 to 2.7	1.65 to 3.6	_	2.0	μА
current	I <sub>CCB</sub>	V <sub>IN</sub> = V <sub>CCA</sub> or GND		1.1 to 2.7	1.65 to 3.6	_	2.0	1
	I <sub>CCA</sub>			1.1 to 2.7	1.65 to 3.6	_	±2.0	
	I <sub>CCB</sub>	$V_{IN} = V_{CCA},$ $V_{CCB} \le B1 \le 3.6 \text{ V}$		1.1 to 2.7	1.65 to 3.6	_	±2.0	

# 10.2. AC Characteristics (Unless otherwise specified, $T_a$ = -40 to 85 °C, Input: $t_f$ = $t_f$ = 2.0 ns)

Characteristics	Symbol	Test Condition	V <sub>CCA</sub> (V)	V <sub>CCB</sub> (V)	Min	Max	Unit		
Propagation delay time	t <sub>PLH</sub> /t <sub>PHL</sub>	See Fig. 10.2.1, 10.2.2,	$2.5 \pm 0.2$	$3.3 \pm 0.3$	0.5	3.2	ns		
(A1 → B1)		Table 10.2.1, 10.2.2.	$1.8\pm0.15$	$3.3 \pm 0.3$	8.0	3.8			
			1.5 ± 0.1	$3.3 \pm 0.3$	1.0	4.5			
			$1.2 \pm 0.1$	$3.3 \pm 0.3$	1.0	6.2			
			$1.8\pm0.15$	$2.5 \pm 0.2$	0.8	4.9			
					1.5 ± 0.1	$2.5 \pm 0.2$	1.0	5.5	
			$1.2 \pm 0.1$	$2.5 \pm 0.2$	1.0	6.9			
			$1.2 \pm 0.1$	$1.8 \pm 0.15$	1.0	9.7			



## 10.3. Capacitive Characteristics (Unless otherwise specified, Ta = 25 °C)

Characteristics	Symbol	Note	Test Condition	V <sub>CCA</sub> (V)	V <sub>CCB</sub> (V)	Тур.	Unit
Input capacitance	C <sub>IN</sub>		A1	2.5	3.3	7	pF
Output capacitance	C <sub>OUT</sub>		B1	2.5	3.3	8	
Power dissipation capacitance	C <sub>PDA</sub>	(Note 1)		2.5	3.3	3	
	C <sub>PDB</sub>			2.5	3.3	13	

Note 1:  $C_{PD}$  is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load. Average operating current can be obtained by the equation.  $I_{CC(opr)} = C_{PD} \times V_{CC} \times f_{|N} + I_{CC}$ 

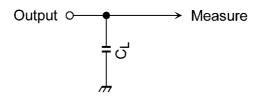


Fig. 10.2.1 AC Test Circuit

Table 10.2.1 Parameter for AC Test Circuit

Parameter	Capacitance	Test Condition
C <sub>L</sub>	30 pF	$V_{CCB}$ = 3.3 ± 0.3 V
		$V_{CCB}$ = 2.5 ± 0.2 V
		$V_{CCB}$ = 1.8 ± 0.15 V

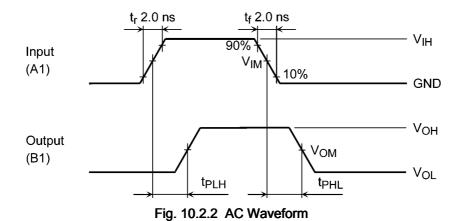


Table 10.2.2 AC Waveform Symbols

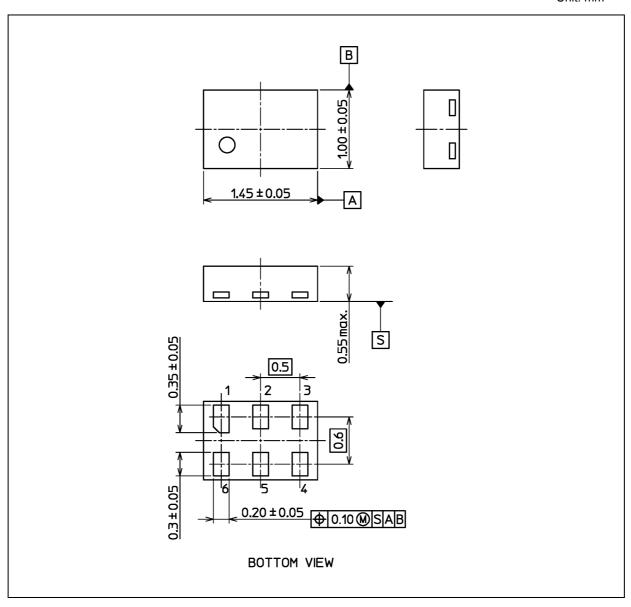
V <sub>CCA</sub> , V <sub>CCB</sub>		Symbol	Value
$3.3\pm0.3~\textrm{V}$	Input	V <sub>IH</sub>	_
		V <sub>IM</sub>	_
	Output	V <sub>OM</sub>	V <sub>OH</sub> /2
2.5 ± 0.2 V	Input	V <sub>IH</sub>	$V_{CCA}$
1.8 ± 0.15 V		V <sub>IM</sub>	V <sub>CCA</sub> /2
	Output	V <sub>OM</sub>	V <sub>OH</sub> /2
1.5 ± 0.1 V	Input	$V_{IH}$	$V_{CCA}$
1.2 ± 0.1 V		V <sub>IM</sub>	V <sub>CCA</sub> /2
	Output	$V_{OM}$	_

2018-08-07



## **Package Dimensions**

Unit: mm



Weight: 0.0024 g (typ.)

Package Name(s)
TOSHIBA: P-UFLGA6-0102-0.50-003
Nickname: MP6C



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